KBU35005 THRU KBU3510

Silicon Bridge Rectifiers 硅桥式整流桥

Reverse Voltage - 50 to 1000 Volts 反向电压 50-1000V Forward Current - 35 Amperes 正向电流 35A

Features 特征

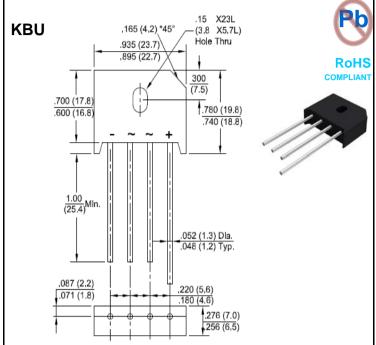
- Low forward voltage drop 正向压降低
- Ideal for printed circuit board 适用于印刷电路板中
- High surge forward current capability 耐正向浪涌电流能力高
- Materials used carries U/L recognition 材料符合UL认证

Mechanical Data 外观信息

- Polarity: Symbol marked on body 极性:标志在产品的本体上
- Mounting position: Any 安装位置: 任何位置

Applications 应用

- General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.
- 一般应用于交流/直流桥式全波整流,如:开关电源,照明镇流器、适配器等。



Package Outline Dimensions in Inches (Millimeters)

封装外观尺寸单位英寸(毫米)

Maximum Ratings and Electrical Characteristics 最大额定值及电气特性

Rating at 25℃ ambient temperature unless otherwise specified. 环境温度25℃,除非特别说明。 Single phase, half wave, 60Hz, resistive or inductive load. 单相半波, 60Hz, 阻性或感性负载。 For capacitive load, derate current by 20%. 对于电容性负载,降低20%的额定电流。

Characteristics 特性	Symbol 符号	KBU 35005	KBU 2504	KBU	KBU 2504	KBU	KBU	KBU 2510	Unit 单位
Maximum Repetitive Peak Reverse Voltage			3501	3502	3504	3506	3508	3510	
最大重复峰值反向电压	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage 最大有效反向电压	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage 最大直流阻断电压	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (with heatsink Note	Lano	35.0 4.2							А
最大正向平均整流电流 @ Tc=100℃ (without heatsink)	I(AV)								
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,									
Superimposed on Rated Load (JEDEC Method)	IFSM	FSM 400							
8.3mS单一正弦半波叠加在额定负载上的浪涌能力(JEDEC方法)									
I ² t Rating for Fusing (t<8.3mS) 熔断额定值 (t<8.3mS)	l ² t	664.0							A ² s
Peak Forward Voltage per Diode at 17.5A DC	\/_	VF 1.1							V
单个二极管在17.5A电流下的正向峰值电压	VF		1.1						V
Maximum DC Reverse Current at Rated @TJ=25℃		10							
DC Bolcking Voltage per Diode @Tյ=125℃	lr	500							μΑ
单个二极管在额定直流电压下的最大反向直流电流		300							
Operating Junction Temperature Range 结温工作范围	TJ	-55 to+150							$^{\circ}$ C
Storage Temperature Range 储存温度范围	Tstg	-55 to+150							$^{\circ}$ C

Note: Device mounted on 100mm*100mm*1.6mm Cu plate heatsink. 安装在100mm*100mm*1.6mm铜板的散热片上



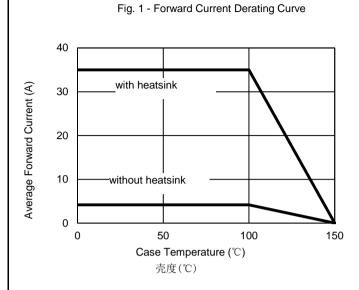
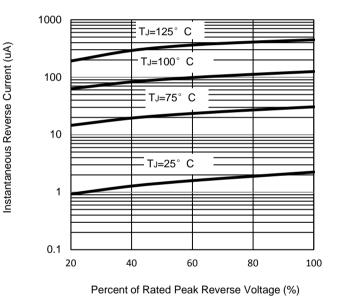


Fig. 3 - Typical Reverse Characteristics



额定峰值反向电压的百分比(%)

Fig. 2 - Maximum Non-Repetitive Surge Current

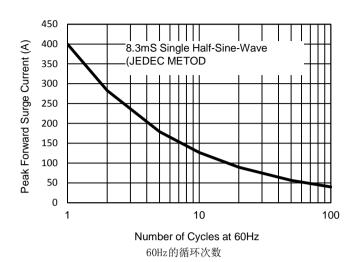
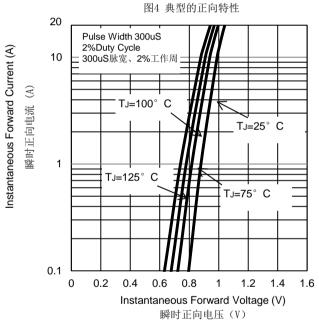


Fig. 4 - Typical Forward Characteristics



The curve above is for reference only. 曲线图仅供参考。



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